TOSHIBA Zener Diode Silicon Epitaxial Planar Type

MUZ Series

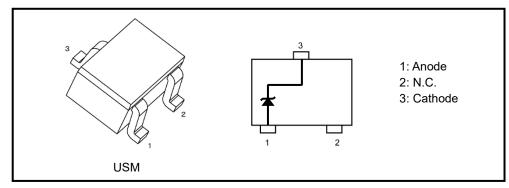
Applications

Voltage surge protection

Features

- Small package
- The typical voltage of Vz is accorded to E24 series

Packaging and Internal Circuit



Absolute Maximum Ratings 1 (Note) (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power dissipation	PD ^{*1}	150	mW
	PD ^{*2}	600	mW
Junction temperature	Тј	150	°C
Storage temperature	T _{stg}	-55 to 150	°C

Absolute Maximum Ratings 2 (Note) (Unless otherwise specified, Ta = 25°C)

Type No.	Electrostatic discharge voltage *3		Peak pulse	Peak pulse Type No.		Electrostatic discharge voltage *3		Peak pulse	Peak pulse
	Contact	Air	power *4	current ^{*4}		Contact	Air	power ^{*4}	current ^{*4}
	V _{ESD} (kV)		P _{PK} (W)	IPP(A)		V _{ESD} (kV)		P _{PK} (W)	I _{PP} (A)
MUZ5V6	± 30		155	12	MUZ16V	± 30		200	5.5
MUZ6V2	± 30		175	11	MUZ20V	± 30		200	5
MUZ6V8	± 30		180	10	MUZ24V	± 30		200	4.5
MUZ8V2	± 30		200	8.5	MUZ30V	± 20		200	4
MUZ12V	± 30		200	7	MUZ36V	± '	12	200	3

- Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).
- *1: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 0.5 mm² x 3
- *2: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 645 mm²
- *3: according to IEC61000-4-2
- *4: according to IEC61000-4-5, tp = 8 / 20 μ s

Start of commercial production 2020-07

MUZ series Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

Type No.	Zener Voltage			Dynamic Impedance		Dynamic resistance	Clamp voltage	Total capacitance	Reverse Current		
• 2 (•)		Test Current	- <u>∠</u> ()	$R_{DYN}(\Omega)^{*1}$	V _C (V) ^{*1*2}	C _t (pF) ^{*3}	I _R (μA)				
	Min	Тур.	Max	I _Z (mA)	Max	I _Z (mA)	Тур.	Тур.	Тур.	Max	V _R (V)
MUZ5V6	5.3	5.6	6.0	5	30	5	0.16	9	125	1	3.5
MUZ6V2	5.8	6.2	6.6	5	30	5	0.21	10	105	2.5	5.0
MUZ6V8	6.4	6.8	7.2	5	30	5	0.27	13	88	1.5	5.5
MUZ8V2	7.7	8.2	8.7	5	30	5	0.37	16.5	67	0.1	7
MUZ12V	11.4	12	12.6	5	30	5	0.7	26	44	0.1	10
MUZ16V	15.3	16	17.1	5	35	5	0.5	27	35	0.1	14
MUZ20V	18.8	20	21.2	5	70	5	0.35	30.5	29	0.1	17.6
MUZ24V	22.8	24	25.6	5	70	5	0.6	36.5	26	0.1	19
MUZ30V	28.0	30	32.0	2	100	2	1.25	47.5	21	0.1	27
MUZ36V	34.0	36	38.0	2	100	2	2.6	63	18	0.1	32.5

*1: TLP parameters: $Z_0 = 50 \ \Omega$, $t_p = 100 \ ns$, $t_r = 300 \ ps$, averaging window: $t_1 = 30 \ ns$ to $t_2 = 60 \ ns$,

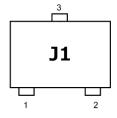
extraction of dynamic resistance using least squares fit of TLP characteristics between $I_{TLP1} = 16$ A and $I_{TLP2} = 30$ A. *2: $I_{TLP} = 16$ A

*3: VR = 0 V, f = 1 MHz

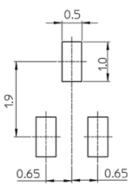
Marking List

Type No.	Marking	Type No.	Marking
MUZ5V6	J1	MUZ16V	J7
MUZ6V2	J2	MUZ20V	JA
MUZ6V8	J3	MUZ24V	JB
MUZ8V2	J4	MUZ30V	JC
MUZ12V	J6	MUZ36V	JD

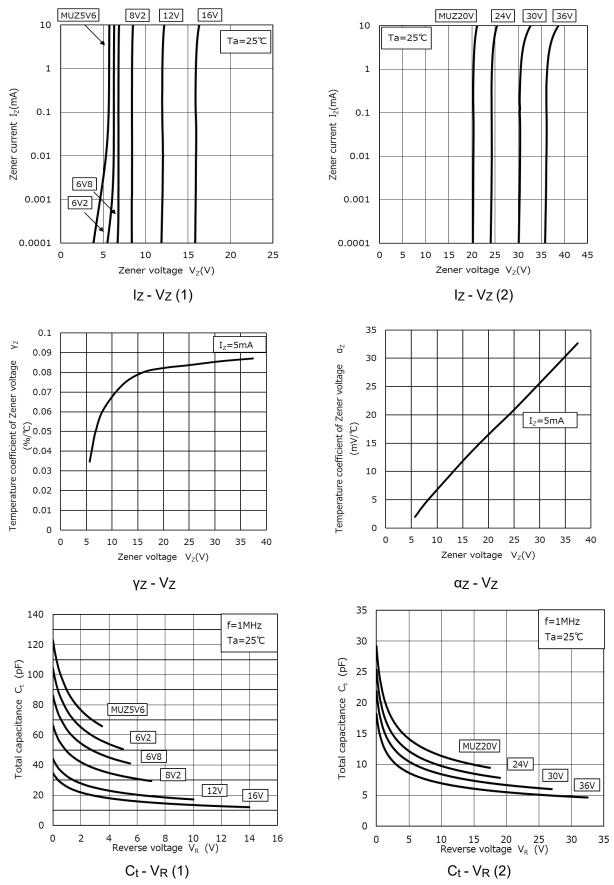
Marking (MUZ5V6)



Land Pattern Dimensions (for reference only) (Unit: mm)



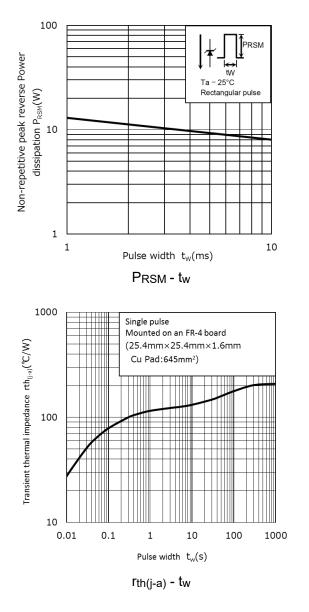
MUZ series Characteristics Curves (Note 1)



Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Mounted on an FR-4 board (25.4mm × 25.4mm × 1.6mm Cu Pad:645mm²)

MUZ series Characteristics Curves (Note 1)



Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

700

600

500

400

300

200

100

0

0

25

50

75

Ambient temperature

PD - Ta

100

125

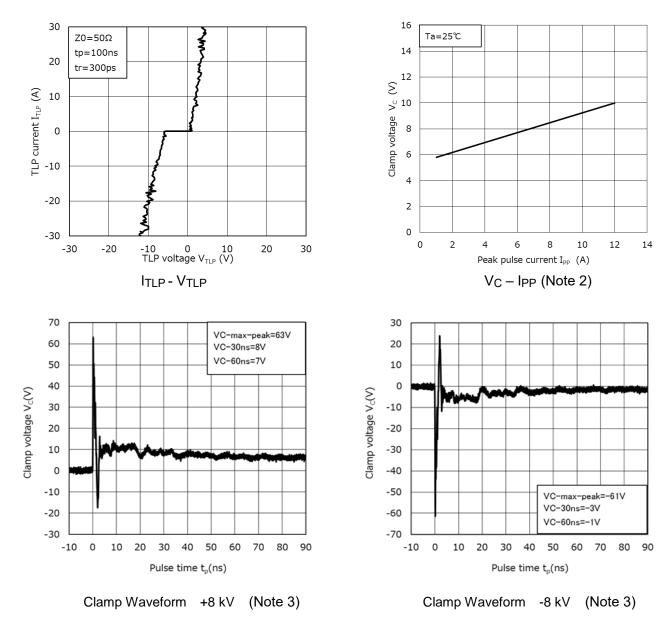
T_a(℃)

150

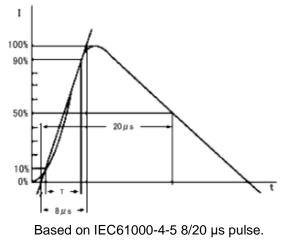
175

Power dissipation P_D (mW)

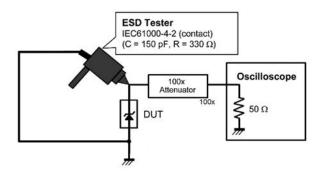
MUZ5V6 Characteristics Curves (Note 1)

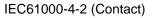




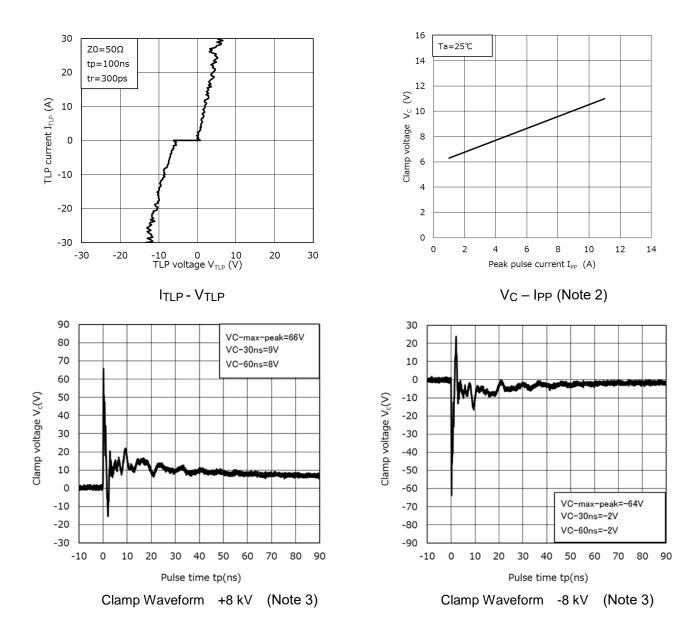


(Note 3) Clamp waveform measurement circuit

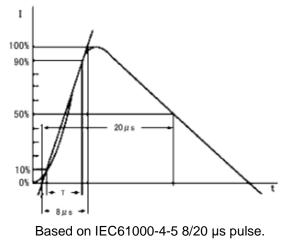




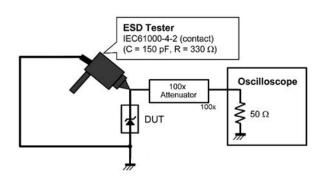
MUZ6V2 Characteristics Curves (Note 1)

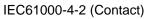




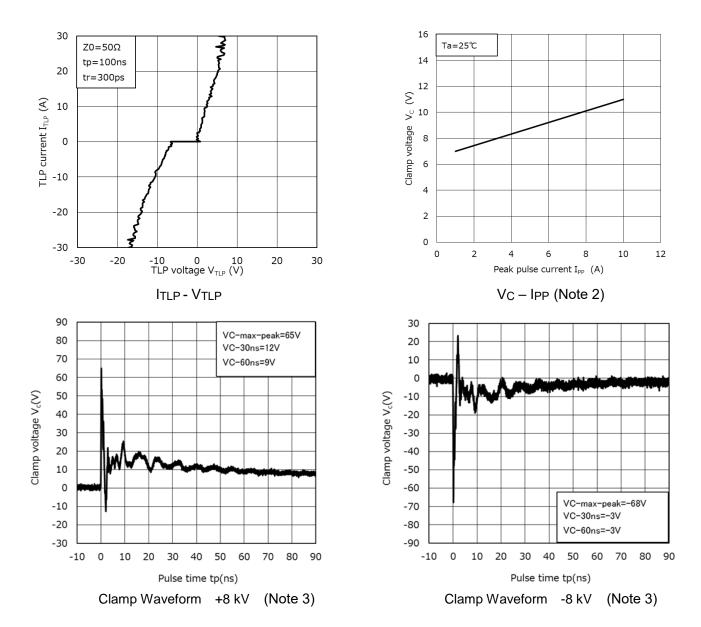


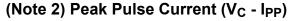
(Note 3) Clamp waveform measurement circuit

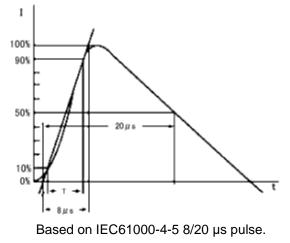




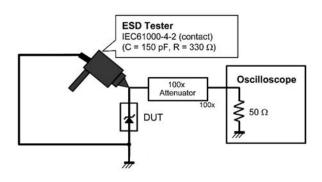
MUZ6V8 Characteristics Curves (Note 1)

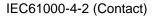




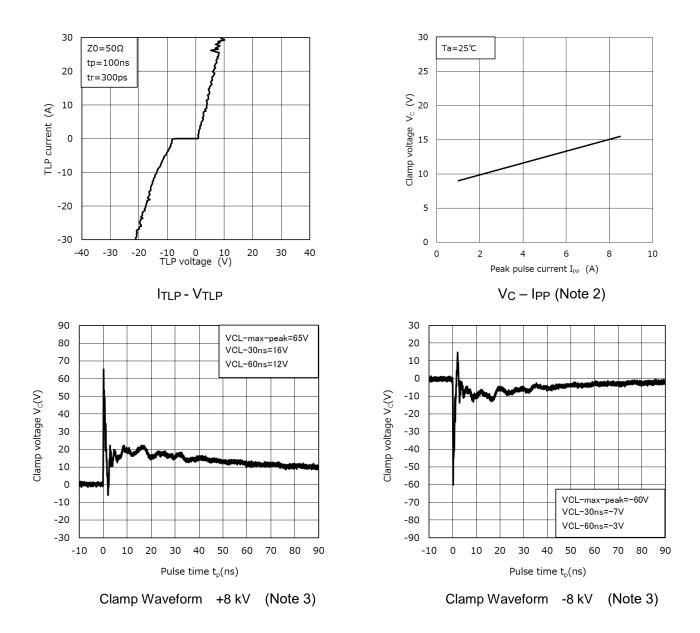


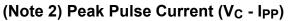
(Note 3) Clamp waveform measurement circuit

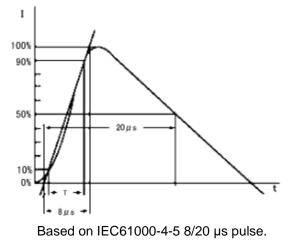




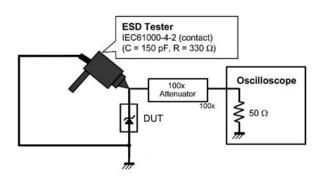
MUZ8V2 Characteristics Curves (Note 1)

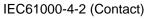




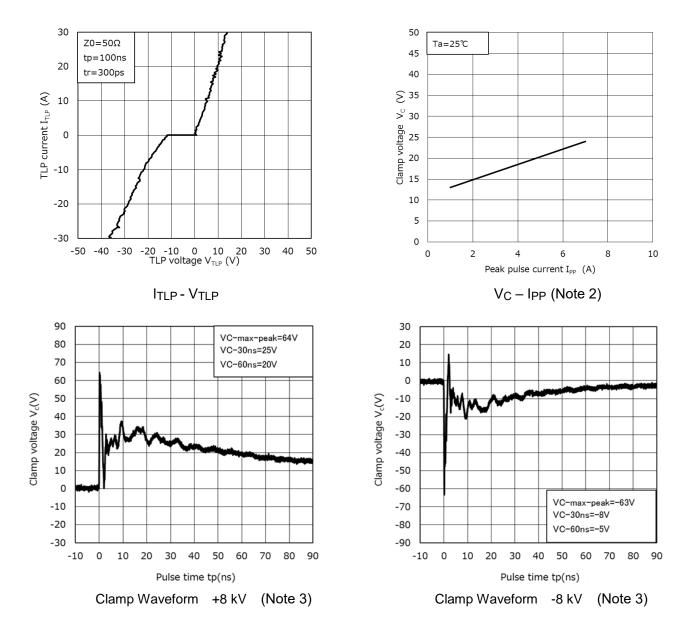


(Note 3) Clamp waveform measurement circuit

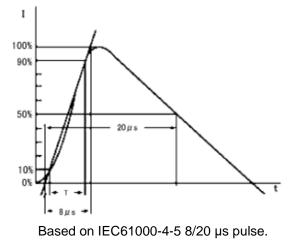




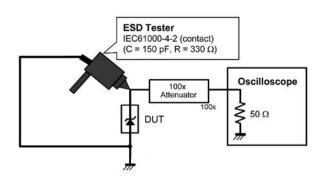
MUZ12V Characteristics Curves (Note 1)



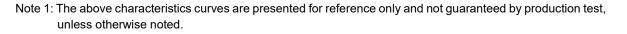




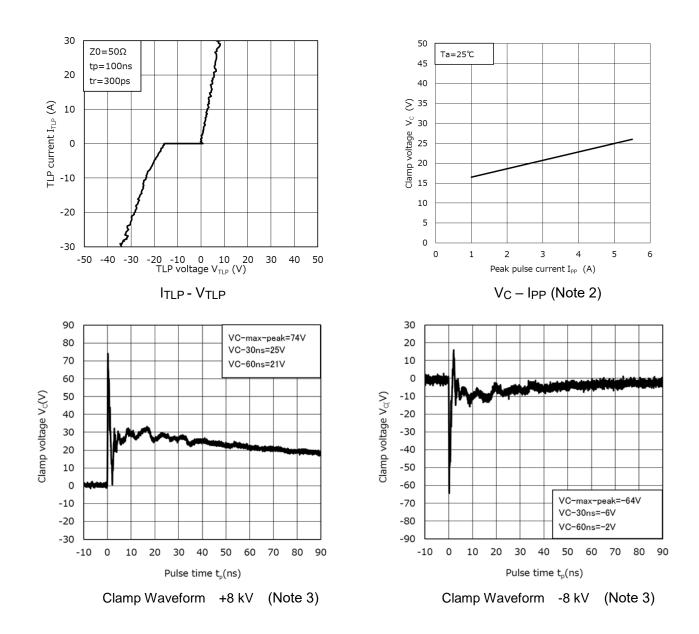
(Note 3) Clamp waveform measurement circuit



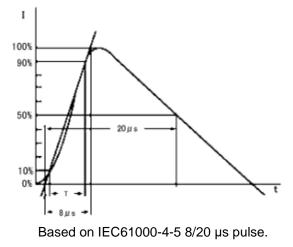
IEC61000-4-2 (Contact)



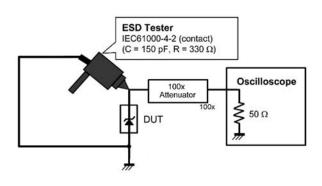
MUZ16V Characteristics Curves (Note 1)



(Note 2) Peak Pulse Current (V_C - I_{PP})

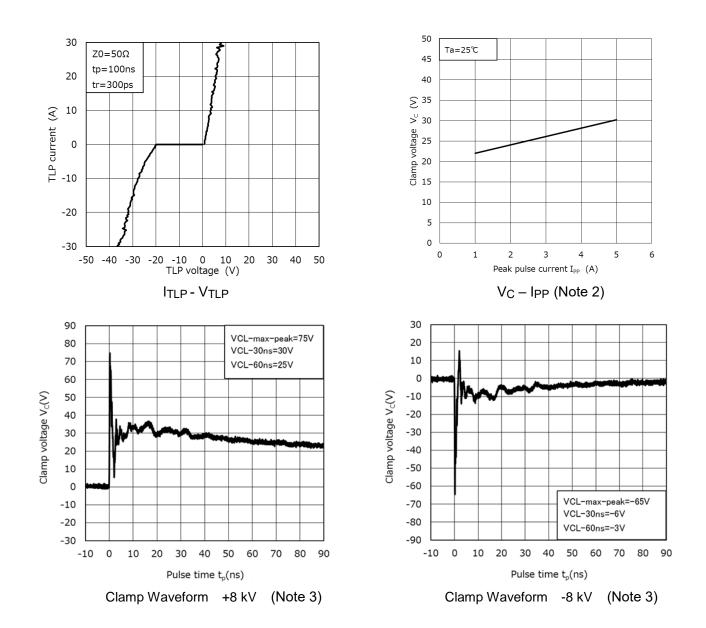


(Note 3) Clamp waveform measurement circuit

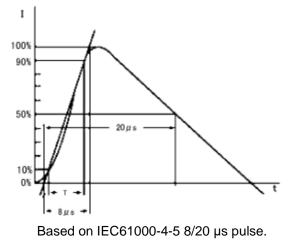


IEC61000-4-2 (Contact)

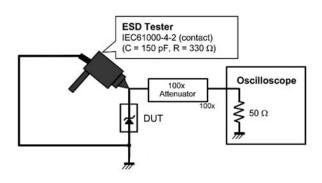
MUZ20V Characteristics Curves (Note 1)





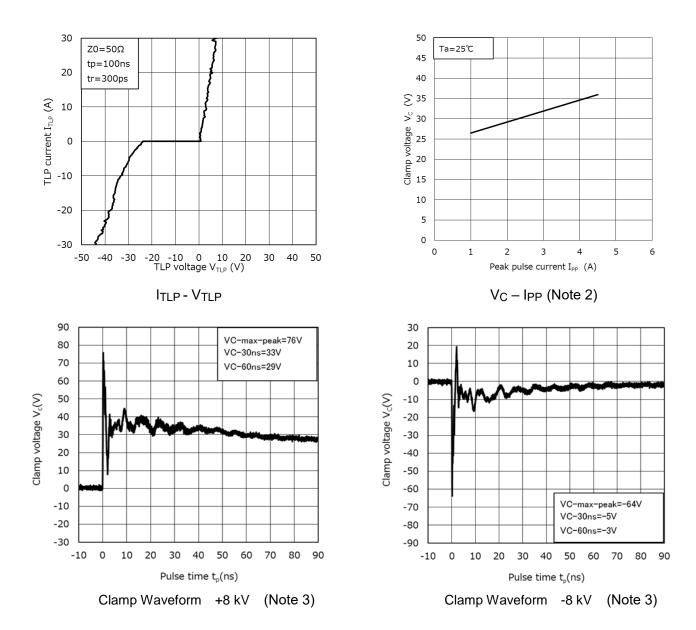


(Note 3) Clamp waveform measurement circuit

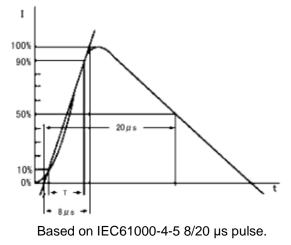


IEC61000-4-2 (Contact)

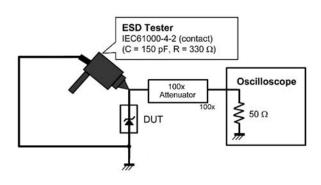
MUZ24V Characteristics Curves (Note 1)





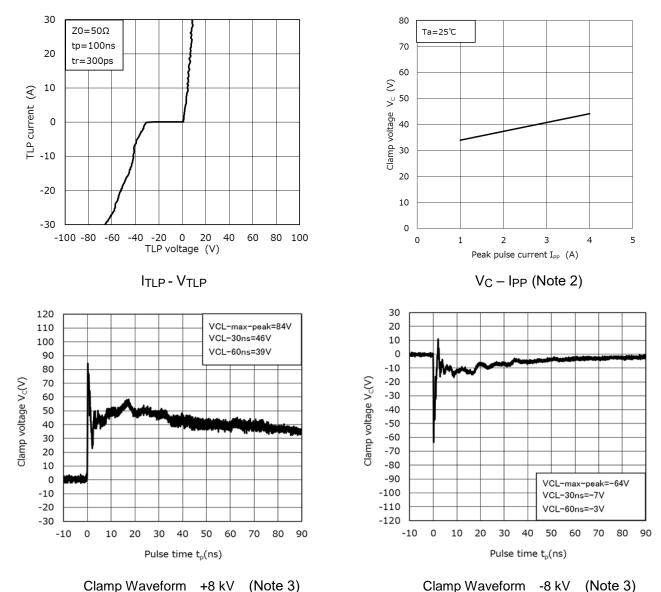


(Note 3) Clamp waveform measurement circuit

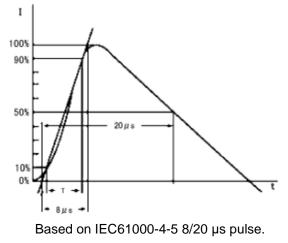


IEC61000-4-2 (Contact)

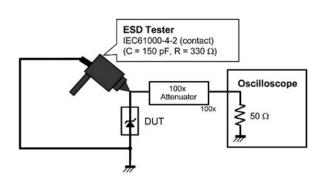
MUZ30V Characteristics Curves (Note 1)

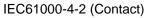




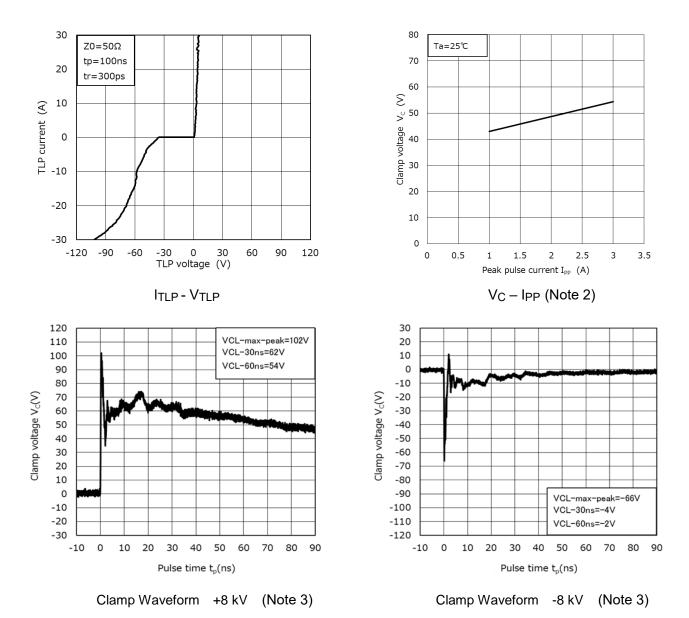


(Note 3) Clamp waveform measurement circuit

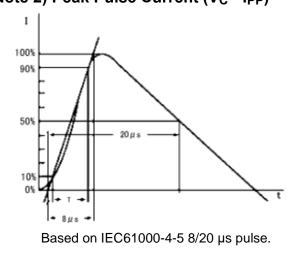




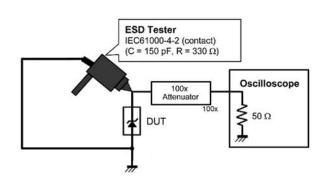
MUZ36V Characteristics Curves (Note 1)

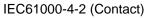






(Note 3) Clamp waveform measurement circuit

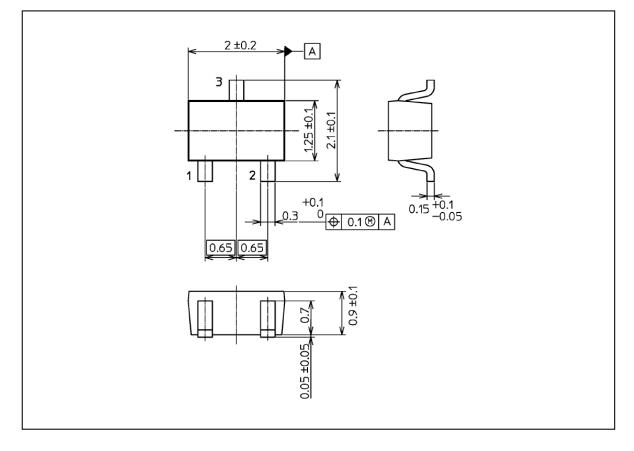






Package Dimensions

Unit: mm



Weight: 6.0 mg (typ.)

RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please
 use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including
 without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT
 OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION

https://toshiba.semicon-storage.com/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Zener Diodes category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below :

 RKZ13B2KG#P1
 DL5234B
 EDZTE6113B
 1N4682
 1N4691
 1N4693
 1N4732A
 1N4733A-TR
 1N4736A
 1N4750A
 1N4759ARL
 1N5241B

 1N5365B
 1N5369B
 1N747A
 1N959B
 1N964B
 1N966B
 1N972B
 NTE5116A
 NTE5121A
 NTE5147A
 NTE5152A
 NTE5155A

 NTE5164A
 JANS1N4974US
 1N4692
 1N4702
 1N4704
 1N4711
 1N4737A
 1N4745ARL
 1N4752A
 1N4752ARL

 1N4760ARL
 1N5221B
 1N5236B
 1N5241BTR
 1N5242BTR
 1N5350B
 1N5352B
 1N961BRR1
 1N964BRL
 RKZ5.1BKU#P6

 3SMAJ5950B-TP
 3SMBJ5925B-TP
 TDZTR24